

Description

The AP3608E is an eight-channel constant current sink with current match used for LED driver. It uses an external resistor to set the current for eight LED strings with an accuracy of $\pm 1.5\%$. The full scale LED current can be adjusted from 10mA to 100mA for each channel. The LED light can be adjusted by PWM dimming function.

The device can keep working when LED opens without damage. It features under voltage lockout protection and over temperature protection.

The AP3608E has four interface terminals (FB, SDB, FBX and SDBX pins). The first two terminals allow the device to work with a DC/DC converter to drive LED arrays for good performance. And the other two enable the device to be connected in parallel.

The AP3608E is available in QFN-4 $\times$ 4-24, TSSOP-20(EDP) and SOIC-20 packages.

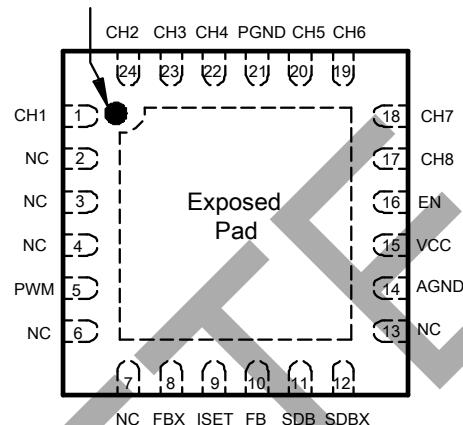
Features

- Input Voltage Range: 4.2V to 5.5V
- Typical Output Current: 480mA (60mA/1V per Channel)
- Maximum Output Current: 800mA (100mA/1.5V per Channel)
- Current Match Accuracy: $\pm 1.5\%$
- PWM Dimming Control
- Open LED Self-check and Protection
- Under Voltage Lockout Protection
- Over Temperature Protection
- FBX and SDBX Pins Enable Parallel Application

Pin Assignments

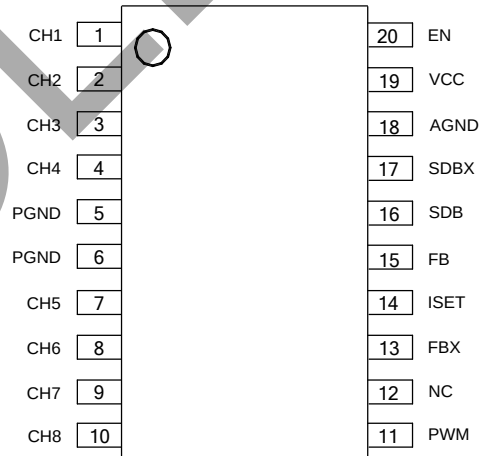
(Top View)

Pin 1 Dot by Marking



QFN-4 $\times$ 4-24

(Top View)



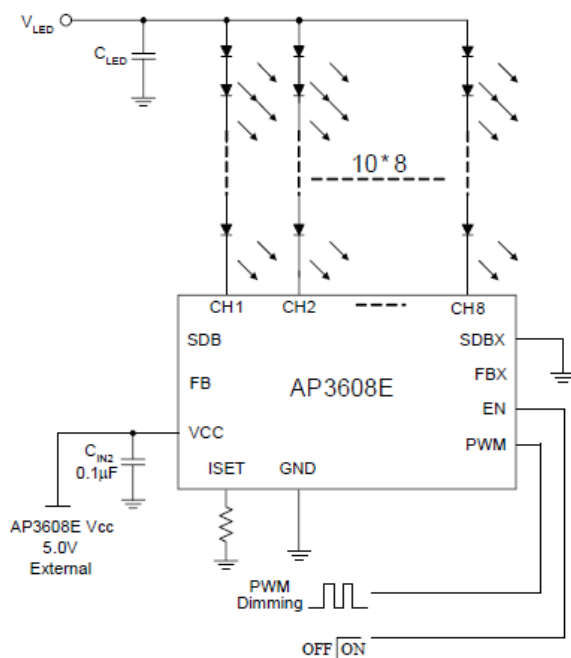
Note: AGND must be quiet and directly connected to total C_{IN}

TSSOP-20(EDP)/SOIC-20

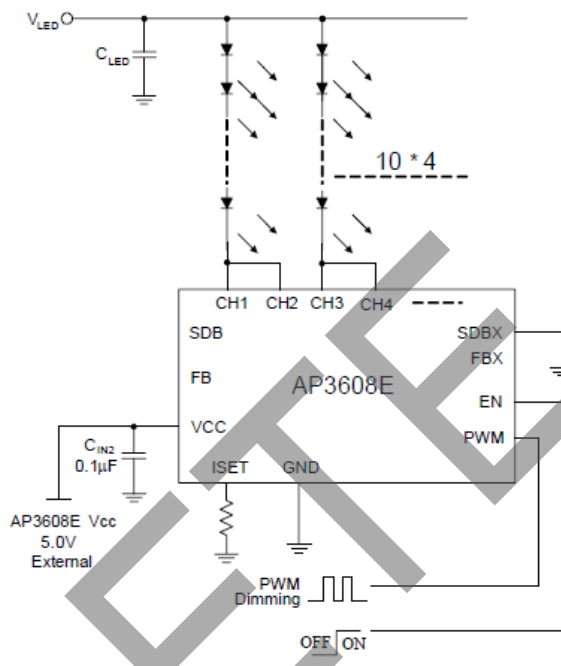
Applications

- Notebook
- LCD Display Modules
- LCD Monitor
- LCD TV

Typical Applications Circuit

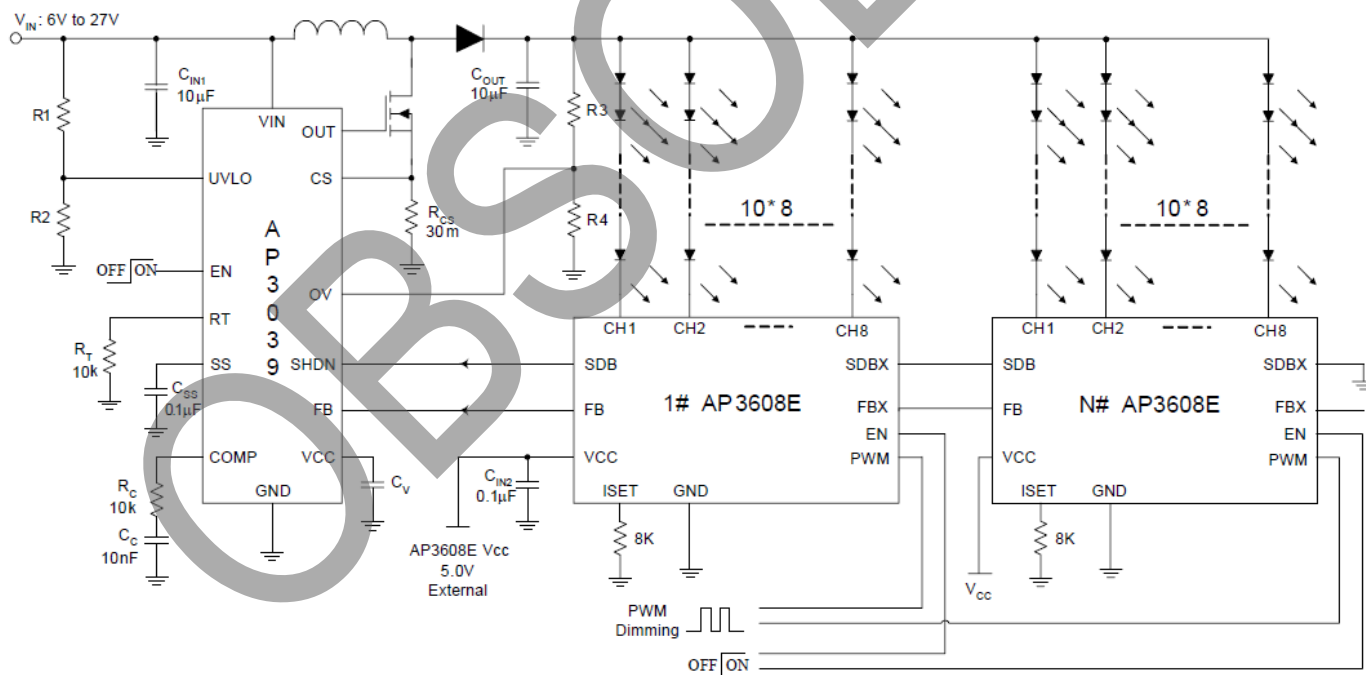


Single Channel



Paralleled Channels

Single Chip Application



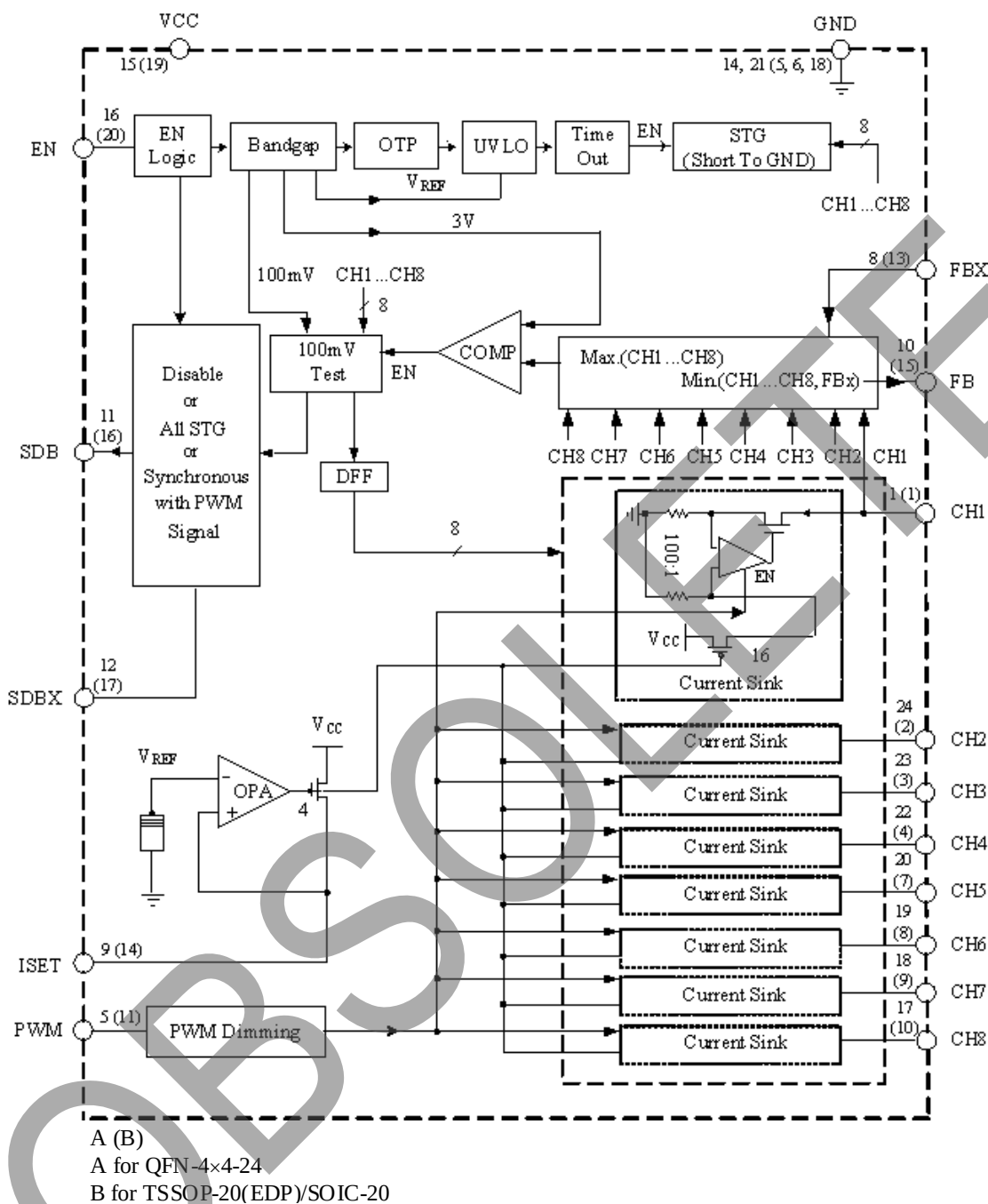
Multi Chips Application

Pin Descriptions

Pin Number		Pin Name	Function
QFN-4x4-24	TSSOP-20(EDP)/SOIC-20		
1, 24, 23, 22, 20, 19, 18, 17	1, 2, 3, 4, 7, 8, 9, 10	CH1to CH8	White LED cathode connection pin. These pins should be connected to GND if not used
2, 3, 4, 6, 7, 13	12	NC	No connection
5	11	PWM	PWM dimming control pin. Adding a PWM signal to this pin to control LED dimming (see Figure 10 for detail dimming control mode). If not used, connect it to the high level
8	13	FBX	This pin is an interface terminal. Connecting it with FB pin can achieve parallel application. If not used, leave it unconnected
9	14	ISSET	LED current set pin. An external resistor is connected to this pin to set each channel current according to $I_{CHANNEL} = 1.194 \times 400 / R_{ISSET}$
10	15	FB	Feedback pin. This pin is an interface terminal, which samples the voltage of each channel, and outputs the lowest voltage of the string to DC/DC converter
11	16	SDB	This pin is an interface terminal. SDB pin outputs low logic to DC/DC converter under the conditions such as AP3608E receives shutdown signal from EN pin or all channels are inactive. When AP3608E is on PWM dimming mode, the signal in SDB pin is synchronous with PWM signal
12	17	SDBX	This pin is an interface terminal. Connecting it with SDB pin can achieve parallel application. If not used, connect it to GND
14	18	AGND	Ground pin. It would be useful when connected with PGND and exposed pad
15	19	VCC	Input voltage pin
16	20	EN	Enable pin. Logic high enables the IC and logic low disables the IC
21	5, 6	PGND	Ground pin. It would be useful when connected with AGND and exposed pad
-	-	EP	Exposed pad. It would be useful when connected with AGND and PGND

OBSOLETE - PART DISCONTINUED

Functional Block Diagram



Absolute Maximum Ratings (Note 1)

Symbol	Parameter	Value		Unit
V _{CC}	Input Voltage	-0.3 to 6		V
V _{ISET}	ISET Pin Voltage	-0.3 to 6		V
V _{EN}	EN Pin Voltage	-0.3 to 6		V
V _{FB}	Feedback Pin Voltage	-0.3 to 6		V
V _{SDB}	SDB Pin Voltage	-0.3 to 6		V
V _{PWM}	PWM Pin Voltage	-0.3 to 6		V
V _{CHX}	Voltage per Channel (Note 3)	-0.3 to 40		V
θ_{JA}	Thermal Resistance (Junction to Ambient, No Heat Sink)	QFN-4×4-24	60	°C/W
		TSSOP-20(EDP)	35 (Note 2)	
		SOIC-20	87	
T _J	Operating Junction Temperature	+150		°C
T _{STG}	Storage Temperature Range	-65 to +150		°C
T _{LEAD}	Lead Temperature (Soldering, 10sec)	+260		°C
—	ESD (Machine Model)	200		V
—	ESD (Human Body Model)	6000		V

Note 1: Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.

Note 2: The chip is soldered to 60mm² (4mm×15mm) copper (top side solder mask) of 1oz. on PCB with 8×0.5mm vias.

Note 3: Breakdown voltage.

Recommended Operating Conditions

Symbol	Parameter		Min	Max	Unit
V _{CC}	Input Voltage		4.2	5.5	V
f _{PWM}	Recommended PWM Dimming Frequency		0.1	25	kHz
I _{CHX}	Full Scale Setting Current per Channel	V _{CHX} ≥0.5V	10	25	mA
		V _{CHX} ≥1V	10	65	
		V _{CHX} ≥1.5V	10	110	
T _A	Operating Temperature Range		-40	+85	°C

Electrical Characteristics (Limits in standard typeface are guaranteed for $V_{IN}=V_{EN}=5V$, $R_{ISET}=8k\Omega$, $T_A=+25^\circ C$, unless otherwise specified.)

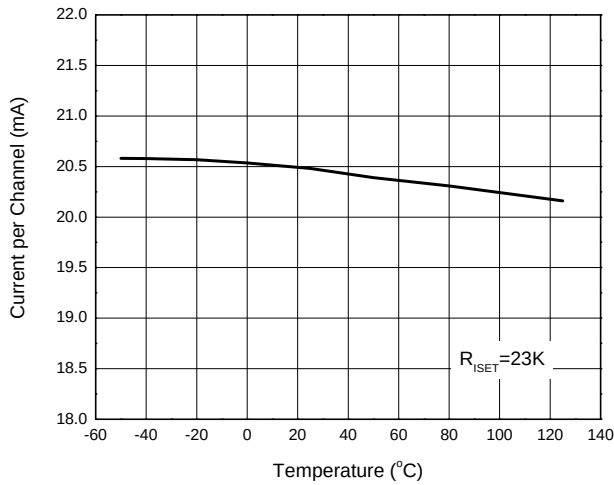
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Input Section						
V_{IN}	Input Voltage	—	4.2	—	5.5	V
I_Q	Quiescent Current	No load	—	0.5	1	mA
I_{SDB}	Shutdown Quiescent Current	$V_{EN}=0V$	—	0.1	1	μA
V_{UVLO}	Under Voltage Lockout Threshold	Falling Edge	3.6	3.8	4.0	V
V_{HUVLO}	Under Voltage Lockout Hysteresis	—	—	200	—	mV
Current Sink Section						
V_{ISET}	ISET Reference Voltage	—	1.170	1.194	1.218	V
K	Current Multiplication Ratio	I_{CHX}/I_{SET}	370	400	430	—
I_{CHX_MAX}	Maximum Output Current per Channel	$V_{CHX}=0.5V$	23	45	—	mA
		$V_{CHX}=1V$	65	70	—	
		$V_{CHX}=1.5V$	110	120	—	
$I_{CH-MATCH}$	Current Matching between Any Two Channels	$I_{CHX}=60mA$ $V_{CHX}=1V$	-1.5	—	1.5	%

Electrical Characteristics (Cont. Limits in standard typeface are guaranteed for $V_{IN}=V_{EN}=5V$, $R_{ISET}=8k\Omega$, $T_A=+25^\circ C$, unless otherwise specified.)

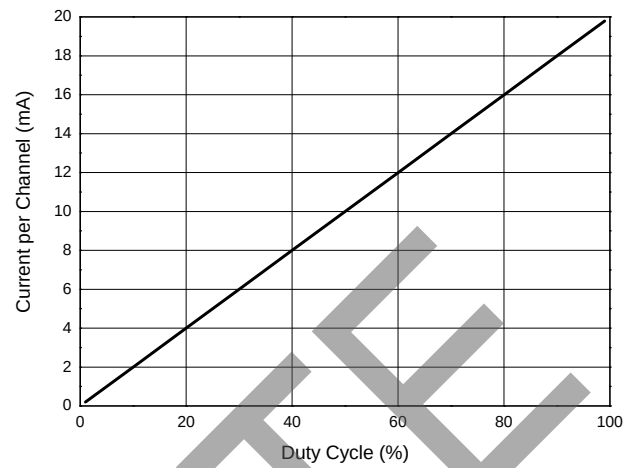
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{CHX_SAT}	Current Sink Saturation Voltage per Channel	$I_{CHX}=20mA$	—	—	0.45	V
		$I_{CHX}=60mA$	—	—	0.8	
		$I_{CHX}=100mA$	—	—	1.2	
—	Output Current Line Regulation	$V_{CC}=4.2V$ to $5.5V$	—	—	2	%/V
—	Output Current Load Regulation	$V_{CHX}=0.5V$ to $2.8V$	—	—	4	%
Enable Section						
V_{IH_EN}	EN Pin High Level Threshold Voltage	—	1.8	—	—	V
V_{IL_EN}	EN Pin Low Level Threshold Voltage	—	—	—	0.8	V
PWM Dimming Section						
V_{IH_PWM}	PWM High Level Threshold Voltage	—	1.8	—	—	V
V_{IL_PWM}	PWM Low Level Threshold Voltage	—	—	—	0.8	V
Interface Section						
V_{OH}	SDB High Level Output Voltage	—	2.4	—	—	V
V_{OL}	SDB Low Level Output Voltage	—	—	—	0.4	V
I_{FB}	Feedback Output Current	—	5	15	—	μA
Total Device						
V_{CHECK}	Self-check Voltage @ Open LED	—	—	3.0	—	V
T_{OTSD}	Thermal Shutdown Temperature	—	—	+160	—	$^\circ C$
T_{HYS}	Thermal Shutdown Hysteresis	—	—	+20	—	$^\circ C$

Performance Characteristics ($V_{IN}=V_{EN}=5V$, $R_{ISET}=8k\Omega$, $T_A=+25^\circ C$, unless otherwise specified.)

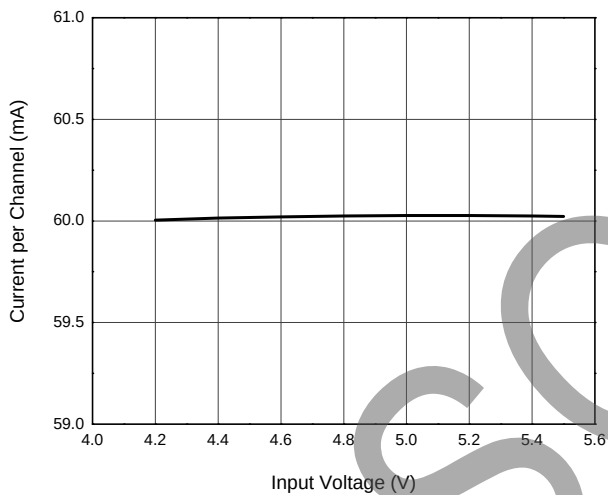
Current Per Channel VS. Temperature



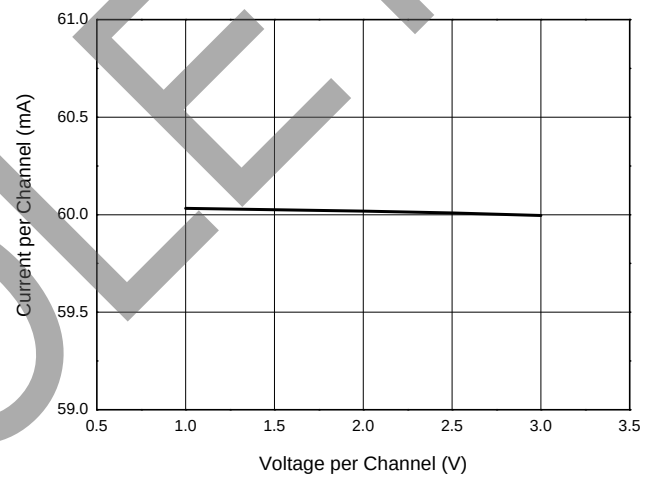
Current Per Channel VS. Duty Cycle



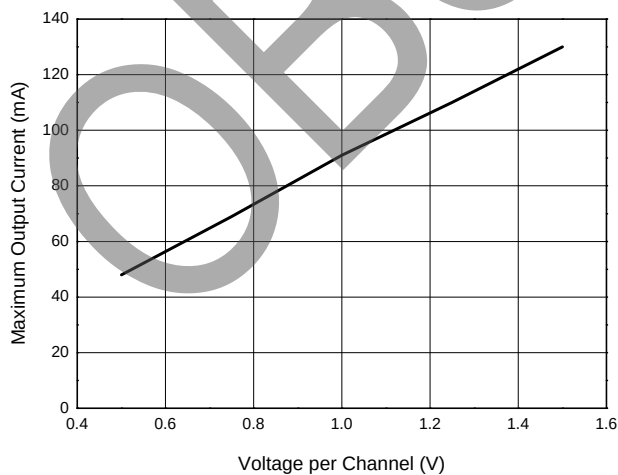
Current Per Channel VS. Input Voltage



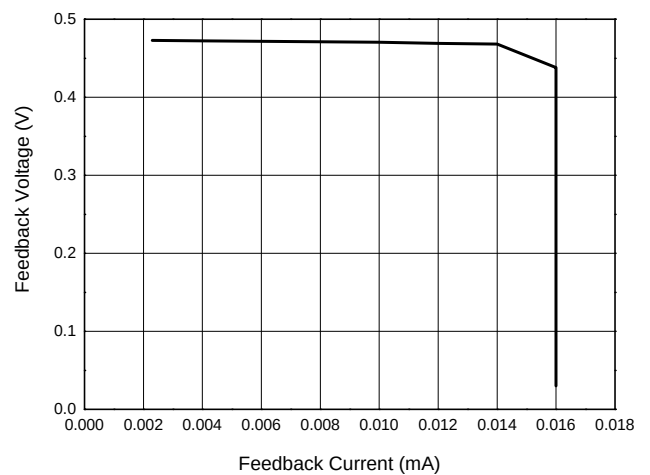
Current Per Channel VS. Voltage Per Channel



Maximum Output Current VS. Voltage Per Channel



Feedback Voltage VS. Feedback Current



Function Description

The AP3608E is designed for LED display application which contains eight well-matched current sinks to provide constant current through LED. The full scale LED current can be adjusted from 10mA to 100mA per channel with an external resistor. If there is some channel unused, the channel pin should be connected to ground. The LED bright dimming can be achieved through PWM dimming.

The AP3608E can work with a DC/DC converter to drive LED arrays for good performance. The device can keep working when LED opens without damage, and it features under voltage lockout protection and over temperature protection. The detailed information will be discussed in open LED self-check and protection section.

1. LED Current Setting

The maximum LED current can be set up to 100mA per channel by ISET pin. When the LED current is greater than 100mA, two or more channels can be paralleled to achieve larger drive current. To set the reference current I_{SET} , connect a resistor R_{ISET} between this pin and ground. The value of R_{ISET} can be calculated by the following formula:

$$I_{SET} = 1.194V / R_{ISET}$$

This reference current is multiplied internally with again (K) of 400, and then mirrored on all enabled channels. This sets the maximum LED current, referred to as 100% current (I_{CHX_MAX}). The value can be calculated by the following formula:

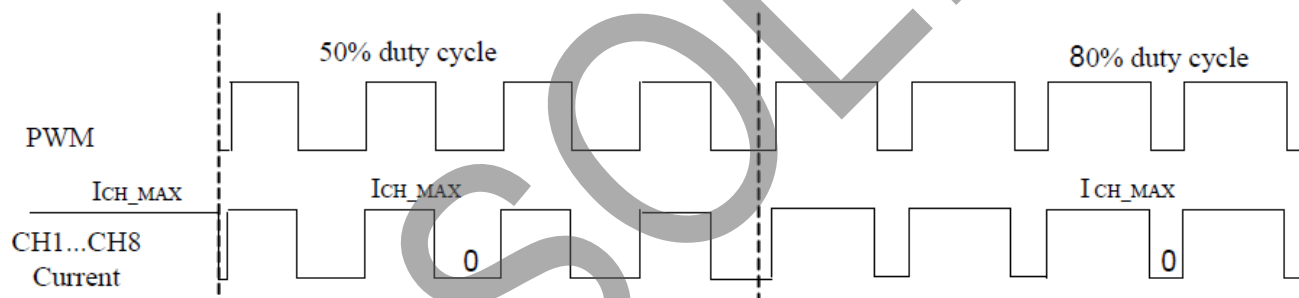
$$I_{CHX_MAX} = K \cdot I_{SET}$$

The LED current can be reduced from 100% by PWM dimming control.

2. PWM Dimming Mode

The LED current can be adjusted by applying the PWM signal to PWM pin. On this mode, all enabled channels are adjusted at the same time and the brightness can be adjusted from 1%* I_{CHX_MAX} to 100%* I_{CHX_MAX} (@ $f_{Dimming}=2kHz$). During the "high level" time of the PWM signal, the LED turns on and the 100% current flows through LED. During the "low level" time of the PWM signal, the LED turns off and almost no current flows through LED. So the average current through LED is changed and the brightness is adjusted. The external PWM signal frequency applied to PWM pin can be allowed to 100Hz or higher.

An example for PWM dimming is shown in Figure of PWM Dimming Example of AP3608E. All 8 channels are set to the maximum current I_{CHX_MAX} at the beginning. When a 50% duty cycle PWM signal is applied to PWM pin, average current valued 50%* I_{CHX_MAX} flows through the 8 channels. When an 80% duty cycle PWM signal is applied to PWM pin, average current valued 80%* I_{CHX_MAX} flows through the 8 channels.



PWM Dimming Example of AP3608E

3. Open LED Self-Check and Protection

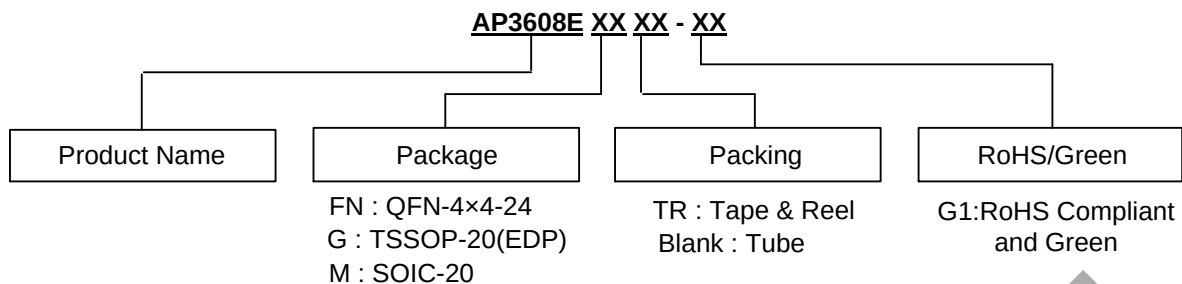
The AP3608E can work with a DC/DC converter to achieve good performance, such as self-check and protection against open LED. The SDB pin and FB pin are the interface terminals for working with the DC/DC converter. FB pin samples voltage of each channel, and outputs the lowest voltage of all strings to DC/DC converter. When AP3608E gets shutdown signal from EN pin or all channels are inactive, SDB pin outputs low logic to DC/DC converter. When AP3608E is on PWM dimming mode, the SDB pin outputs the signal which is synchronous with PWM signal to DC/DC converter. Figure 11 is the typical circuit of AP3608E applied with a boost converter AP3039.

If any enabled LED string opens, voltage on the corresponding CHX pin goes to zero and the FB pin outputs the zero voltage to boost converter. So the boost converter operates in open loop and the voltage on remaining CHX pin goes higher. Once the voltage on remaining CHX pin reaches the self-check voltage 3V, the AP3608E begins looking up the open string. After finding the open channel, AP3608E removes the corresponding CHX pin from boost control loop, then the boost circuit is controlled in the normal manner. Once the circuit returns normal operation, the voltage on the CHX pin is regulated to the normal level. It is necessary to pay attention that the open strings are removed from boost regulation, but not disabled. If the open LED string is reconnected, it will sink current up to the programmed current level.

4. Parallel Operation Mode

The AP3608E can be paralleled to drive more strings of LED. Connecting an AP3608E SDB pin and FB pin with another AP3608E SDBX pin and FBX pin can achieve parallel application. More details please refer to Figure of Typical Applications of AP3608E.

Ordering Information

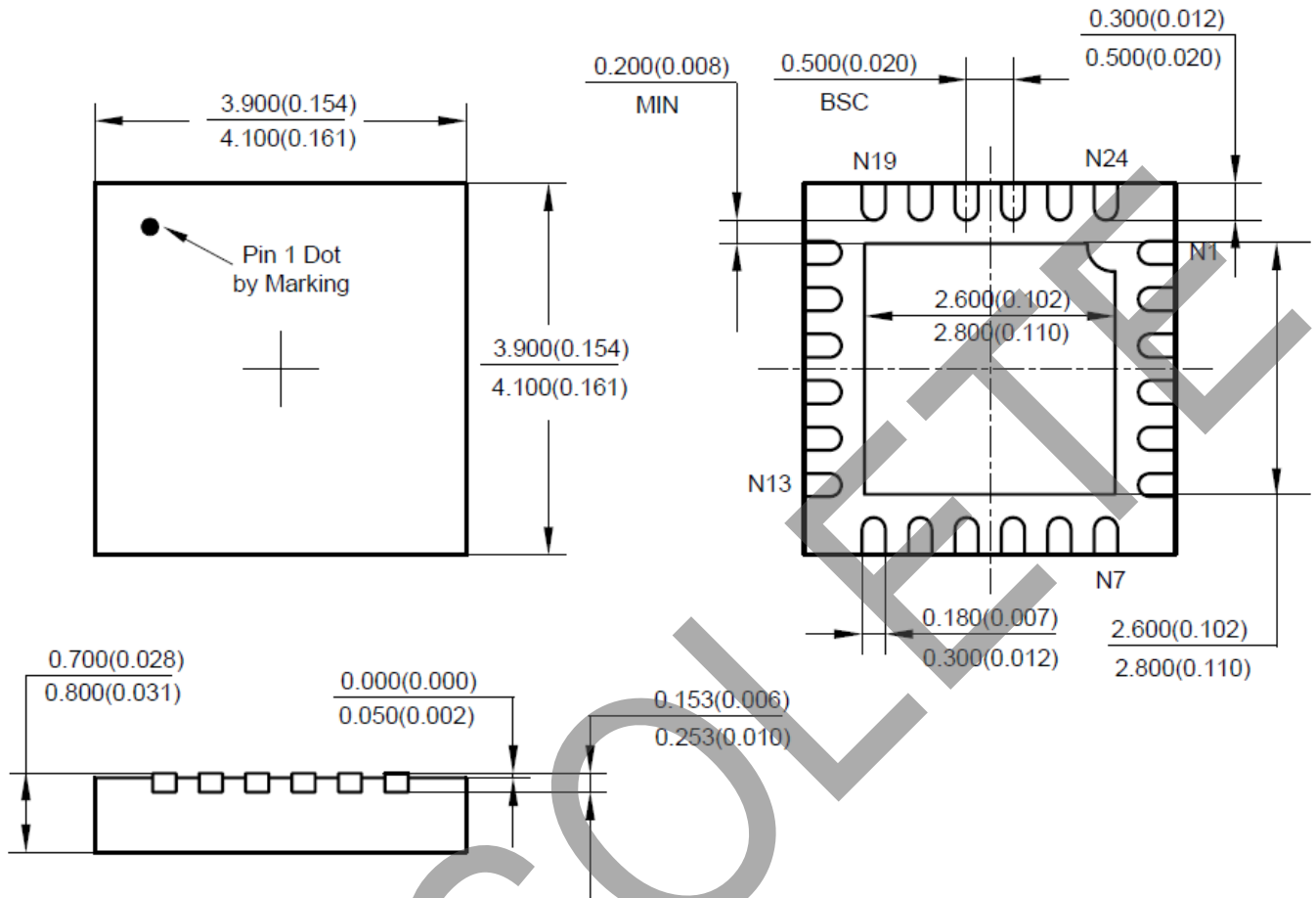


Package	Temperature Range	Part Number	Marking ID	Packing
QFN-4×4-24	-40 to+ 85°C	AP3608EFNTR-G1	B3B	Tape & Reel
TSSOP-20(EDP)		AP3608EGTR-G1	AP3608EG-G1	Tape & Reel
SOIC-20		AP3608EM-G1	AP3608EM-G1	Tube
		AP3608EMTR-G1	AP3608EM-G1	Tape & Reel

OBSOLETE

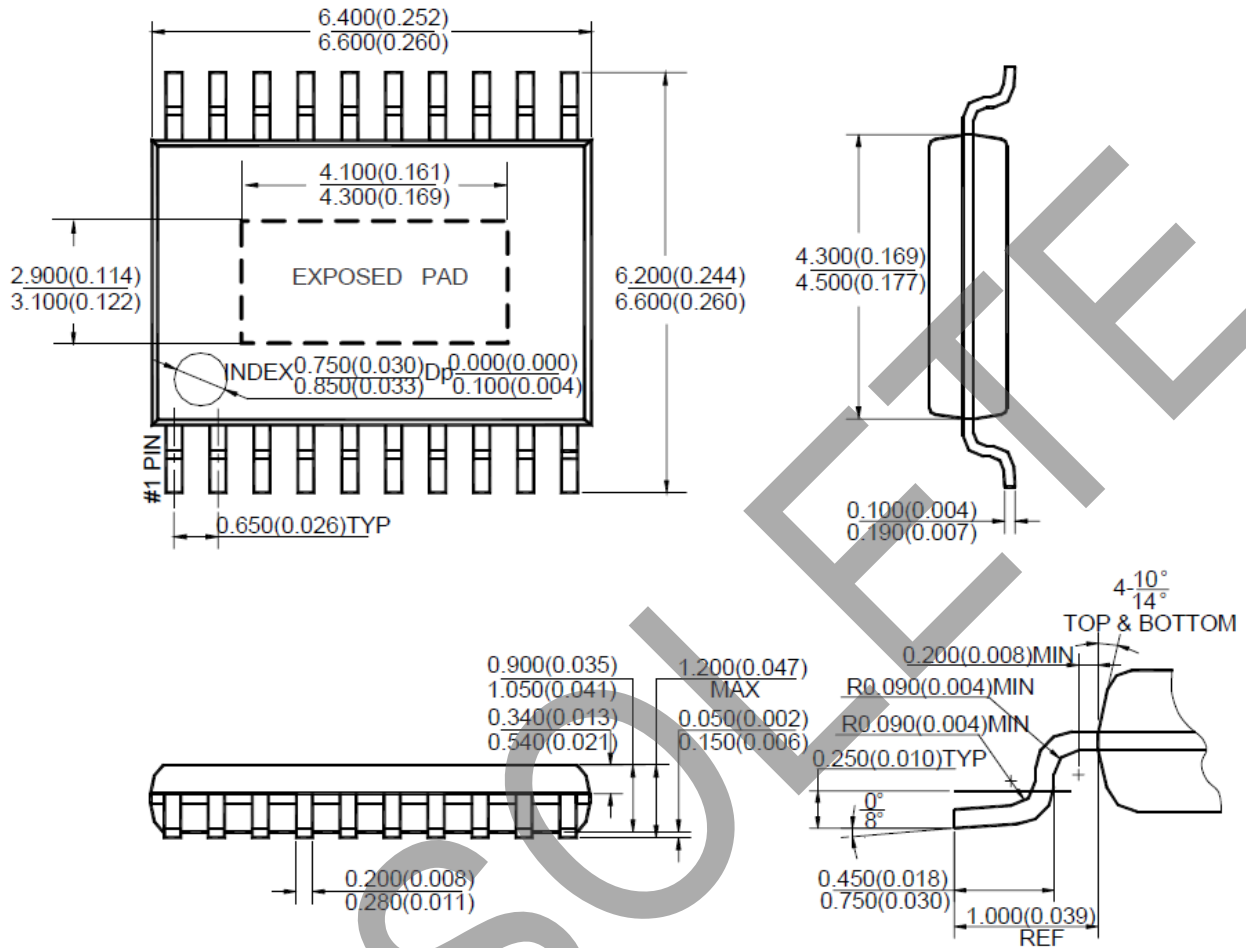
Package Outline Dimensions (All dimensions in mm(inch).)

(1) Package Type: QFN-4x4-24



Package Outline Dimensions (Cont. All dimensions in mm(inch).)

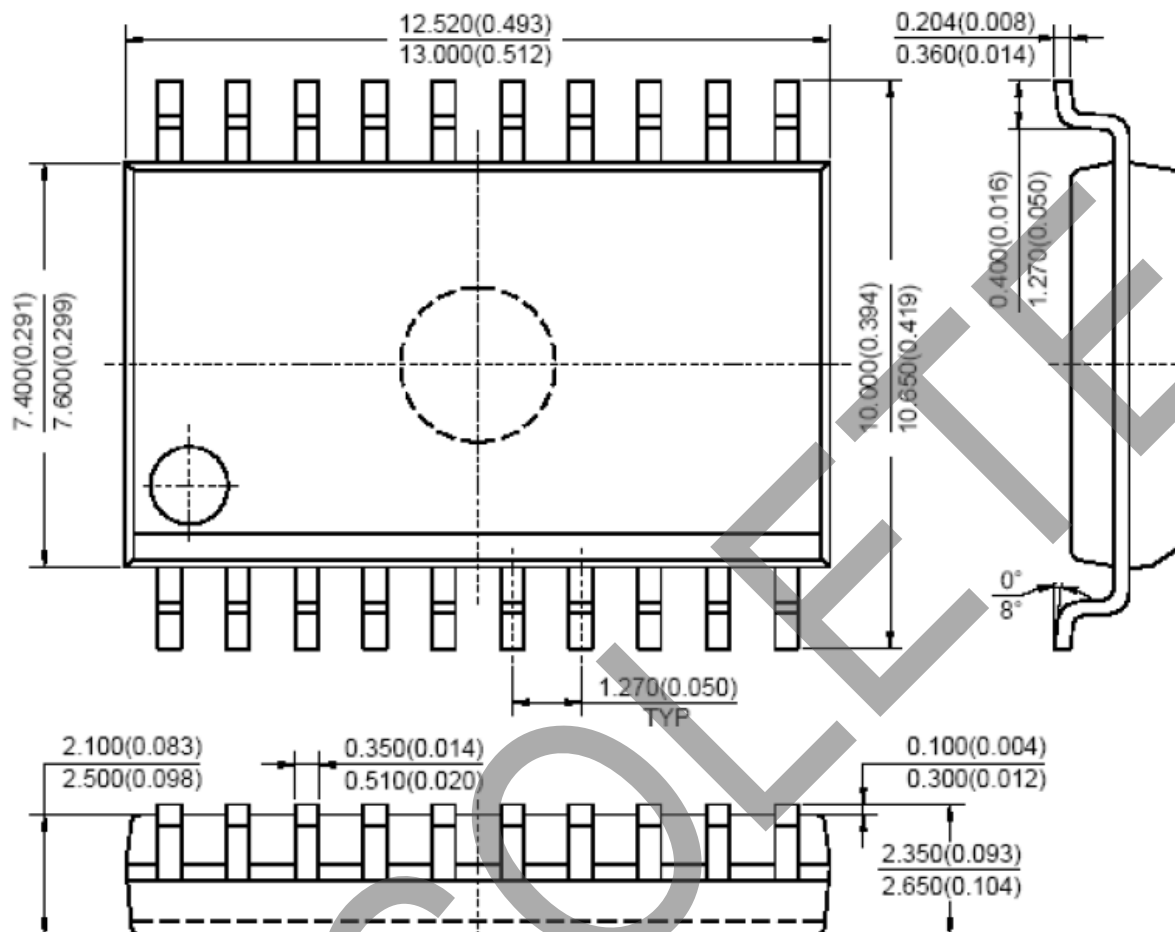
(2) Package Type: TSSOP-20(EDP)



Note: Eject hole, oriented hole and mold mark is optional.

Package Outline Dimensions (Cont. All dimensions in mm(inch).)

(3) Package Type: SOIC-20



Note: Eject hole, oriented hole and mold mark is optional.

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